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TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS IV)

# **TPC8030**

Lithium Ion Battery Applications
Portable Equipment Applications
Notebook PC Applications

• Small footprint due to small and thin package

• Low drain-source ON-resistance:  $RDS(ON) = 7.5 \text{ m}\Omega \text{ (typ.)}$ 

• High forward transfer admittance:  $|Y_{fs}| = 26 \mathrm{S}$  (typ.)

• Low leakage current:  $IDSS = 10 \mu A (max) (VDS = 30 V)$ 

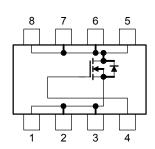
• Enhancement mode:  $V_{th} = 1.3 \text{ to } 2.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$ 

## Absolute Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	30	V	
Drain-gate voltage (R	GS = 20 kΩ)	$V_{DGR}$	30	V	
Gate-source voltage		V <sub>GSS</sub>	± 25	V	
Drain current	DC (Note 1)	ID	11	Α	
Diain current	Pulse (Note 1)	I <sub>DP</sub>	44	^	
Drain power dissipation	on $(t = 10 s)$ (Note 2a)	$P_{D}$	1.9	W	
Drain power dissipation	on (t = 10 s) (Note 2b)	P <sub>D</sub>	1.0	W	
Single pulse avalanch	ne energy (Note 3)	E <sub>AS</sub>	31	mJ	
Avalanche current	Avalanche current		11	Α	
Repetitive avalanche	energy Note 2a) (Note 4)	E <sub>AR</sub>	0.053	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature	range	T <sub>stg</sub>	-55 to 150	°C	

Weight: 0.080 g (typ.)

#### **Circuit Configuration**



Note: Note 1, Note 2, Note 3 and Note 4: See the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

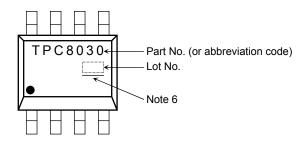
This transistor is an electrostatic-sensitive device. Handle with care.



#### **Thermal Characteristics**

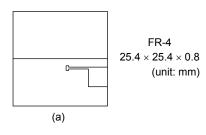
Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	65.8	°C/W	
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R <sub>th (ch-a)</sub>	125	°C/W	

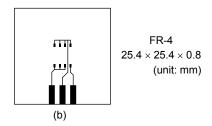
### Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (b) Device mounted on a glass-epoxy board (b)



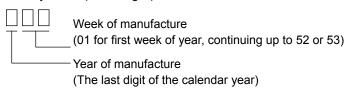


Note 3:  $V_{DD} = 24 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 0.2 mH,  $I_{AR} = 11 \text{ A}$ 

Note 4: Repetitive rating: pulse width limited by max channel temperature

www.DataSharatali.com on the lower left of the marking indicates Pin 1.

\* Weekly code: (Three digits)



Note 6: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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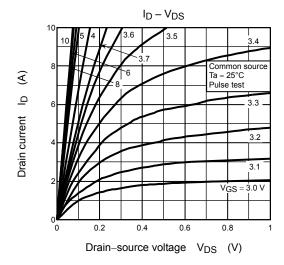
# Electrical Characteristics (Ta = 25°C)

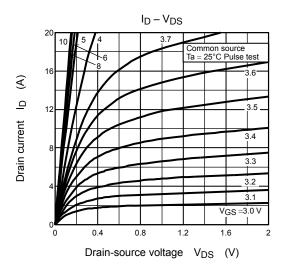
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA
Drain cut-OFF current		I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	_	_	10	μА
Drain-source breakdown voltage		V <sub>(BR)</sub> DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V 30		_	_	V
		V <sub>(BR) DSX</sub>	$I_D = 10$ mA, $V_{GS} = -25$ V	5	_	_	V
Gate threshold vo	Gate threshold voltage		V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.3	_	2.5	٧
Drain-source ON-resistance		D	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 5.5 A	_	11.5	17	mΩ
		R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.5 A	_	7.5	9	
Forward transfer admittance		Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.5 A	13	26	_	S
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	1140	_	pF
Reverse transfer	Reverse transfer capacitance			_	255	_	
Output capacitand	Output capacitance			_	390	_	
	Rise time	t <sub>r</sub>	V <sub>GS</sub> 10 V   I <sub>D</sub> = 5.5 A   C   C   C   C   C   C   C   C   C	_	14	_	ns
	Turn-ON time	t <sub>on</sub>		_	25	_	
Switching time	Fall time	t <sub>f</sub>		_	9	_	
	Turn-OFF time	t <sub>off</sub>	α α ν ν ν ν ν ν ν ν ν ν ν ν ν ν ν ν ν ν	_	33	_	
Total gate charge (gate-source plus gate-drain)		Qg		_	24	_	
Gate-source charge 1		Q <sub>gs1</sub>	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}$	_	4	_	nC
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	8.4	_	

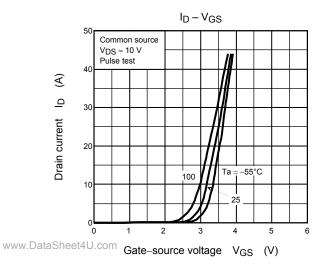
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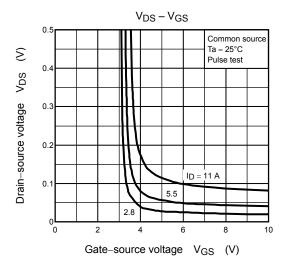
# Source-Drain Ratings and Characteristics (Ta = 25°C)

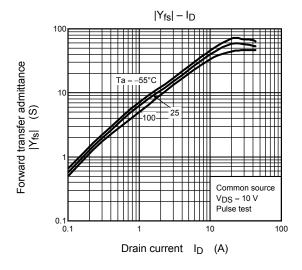
Characteri	stics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse	(Note 1)	I <sub>DRP</sub>	_	_	_	44	Α
Forward voltage (diode)			V <sub>DSF</sub>	I <sub>DR</sub> = 11 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V

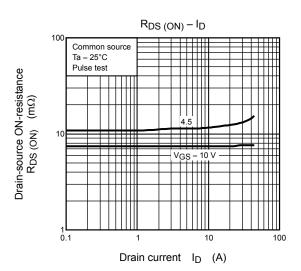




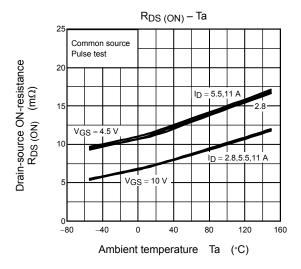


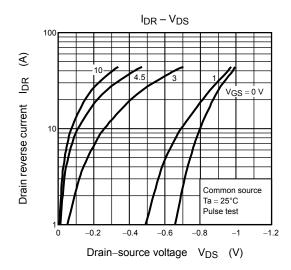


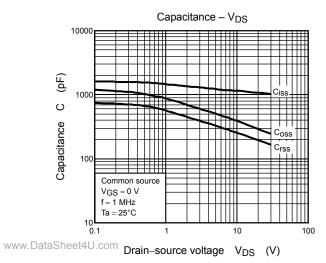


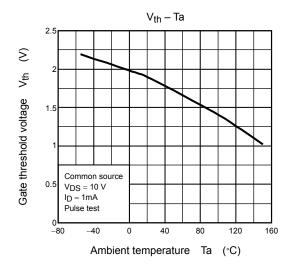


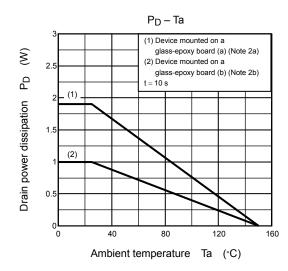
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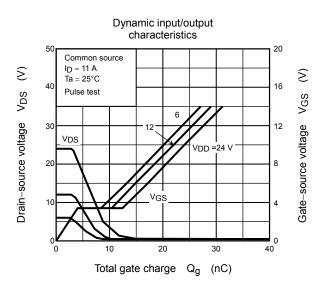


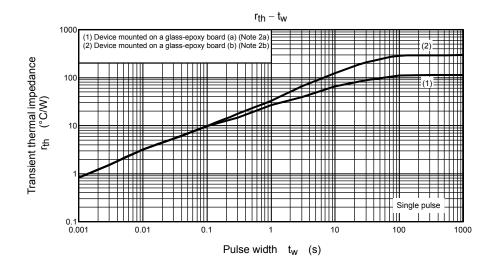


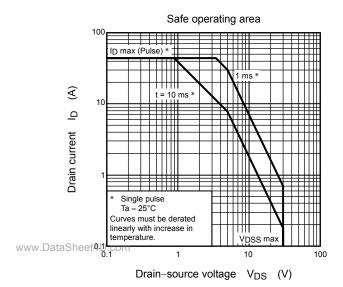












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